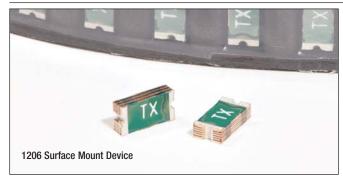


# 6-60 Volt DC Surface Mount, PolyTron™ PTC Devices PolyTron™ PTS1206 Series









#### Description

- PolyTron™ surface mount PTC device
- 6 to 60 volts
- Current ratings from 0.05 to 2.0 amps
- Fast time-to-trip
- Low resistance
- · Halogen free
- Lead free
- RoHS compliant

#### **Agency Information**

- cURus: Recognized Card: File E343021 (Ihold 0.05-2.0A)
- TUV File: R 50192872

# Part Number System/Ordering

	PT	<u>Ş</u>	<u>1206</u>	<u>6V</u>	<u>110</u>
PolyTron™ PTC Device Series					
Surface Mount ————					
Dimension Code ————					
Maximum Voltage ————					
Current Holding (Ipold) ————					

Tape and Reel Packaging/Quantities

- PTS120630V012, PTS120630V016, PTS120624V020, PTS120616V025, PTS120616V035, PTS12066V050, PTS12066V075 - 5000 PTC devices per reel
- All others 2500 PTC devices per reel

# **Applications**

- Medical equipment
- · White goods
- Telecommunications
- Computers and peripherals
- · Rechargeable battery packs

	Specifications											
	Mark			Ihold	Itrip	Pd			Resis	tance (Ω)	Agency	
Catalog	0n	V <sub>max</sub>	I <sub>max</sub>	@23°C	@23°C	Тур.	Time to Ti	rip (Max.)	Initial (R <sub>i</sub> )	Post Trip (R <sub>1</sub> )	Inform	ation
Number	Part	(Vdc)	(Amps)	(Amps)	(Amps)	(W)	(Amps)	(Sec)	Min.	Max.	cURus	TUV
PTS120660V005	TH	60	100	0.05	0.15	0.4	0.25	1.5	3.6	50	Х	X
PTS120660V010	TY	60	100	0.10	0.25	0.4	0.50	1.0	1.6	15	X	X
PTS120630V012	TJ	30	100	0.12	0.29	0.5	1.00	0.2	1.4	6	Х	X
PTS120630V016	TK	30	100	0.16	0.37	0.5	1.00	0.3	1.1	4.5	Х	X
PTS120624V020	TL	24	100	0.20	0.42	0.6	8.00	0.1	0.65	2.6	Х	X
PTS120616V025	TN	16	100	0.25	0.50	0.6	8.00	0.08	0.55	2.3	Х	X
PTS120616V035	TP	16	100	0.35	0.75	0.6	8.00	0.1	0.3	1.2	Х	X
PTS12066V050	TQ	6	100	0.50	1.00	0.6	8.00	0.1	0.15	0.7	X	X
PTS120615V050	TQ1	15	100	0.50	1.00	0.6	8.00	0.1	0.15	0.7	X	X
PTS12066V075	TR	6	100	0.75	1.50	0.6	8.00	0.1	0.1	0.29	Х	X
PTS12066V100	TS	6	100	1.00	1.80	0.8	8.00	0.3	0.065	0.21	Х	X
PTS12066V110	TU	6	100	1.10	2.20	0.8	8.00	0.1	0.07	0.2	X	Χ
PTS12066V150	TV	6	100	1.50	3.00	0.8	8.00	0.3	0.04	0.12	X	Χ
PTS12066V200	TX	6	100	2.00	3.50	1.0	8.00	1.5	0.02	0.08	Χ	Х

Notes:

 $I_{\mbox{hold}} - \mbox{Hold current: Maximum current device will pass without interruption in 23 ^{\circ} \mbox{C still air.}}$ 

trip - Trip current: Minimum current that will switch the device from low resistance to high resistance in 23°C still air.

V<sub>max</sub>: Maximum continuous voltage device can withstand without damage at rated current.

 $I_{\text{max}}$ . Maximum fault current device can withstand without damage at rated voltage.  $P_{\text{d}}$ : Power dissipated from device when in the tripped state in 23°C still air.

R<sub>i</sub> (min.): Minimum resistance of device as supplied at 23°C unless otherwise specified.

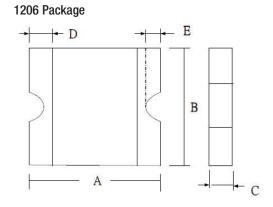
R<sub>1</sub>(max.): Maximum resistance of device when measured one hour post reflow (SMD) or one hour post trip (radial-leaded device) at 23°C unless otherwise specified.

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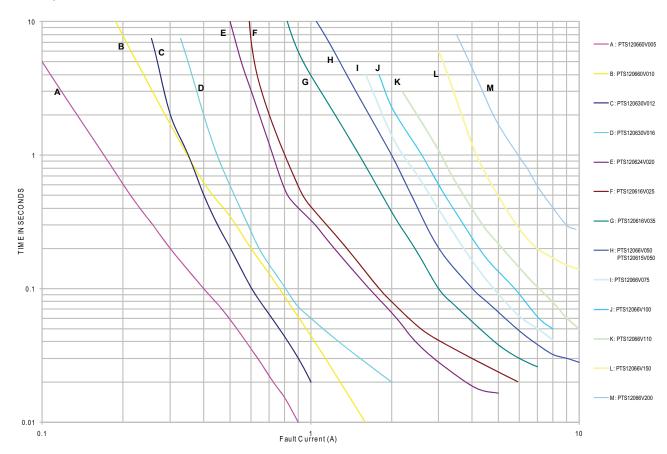


# Dimensions - mm

	А		[	3	(	)	D	[	
Part Number	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Min.	Max.
PTS120660V005	3.00	3.50	1.50	1.80	0.50	0.90	0.125	0.08	0.45
PTS120660V010	3.00	3.50	1.50	1.80	0.50	0.90	0.125	0.08	0.45
PTS120630V012	3.00	3.50	1.50	1.80	0.35	0.90	0.125	0.08	0.45
PTS120630V016	3.00	3.50	1.50	1.80	0.28	0.68	0.125	0.08	0.45
PTS120624V020	3.00	3.50	1.50	1.80	0.28	0.68	0.125	0.08	0.45
PTS120616V025	3.00	3.50	1.50	1.80	0.28	0.68	0.125	0.08	0.45
PTS120616V035	3.00	3.50	1.50	1.80	0.28	0.68	0.125	0.08	0.45
PTS12066V050	3.00	3.50	1.50	1.80	0.28	0.68	0.125	0.08	0.45
PTS120615V050	3.00	3.50	1.50	1.80	0.28	1.06	0.125	0.08	0.45
PTS12066V075	3.00	3.50	1.50	1.80	0.28	0.85	0.125	0.08	0.45
PTS12066V100	3.00	3.50	1.50	1.80	0.40	0.88	0.125	0.08	0.45
PTS12066V110	3.00	3.50	1.50	1.80	0.40	0.88	0.125	0.08	0.45
PTS12066V150	3.00	3.50	1.50	1.80	0.55	1.15	0.125	0.08	0.45
PTS12066V200	3.00	3.50	1.50	1.80	0.55	1.15	0.125	0.08	0.45

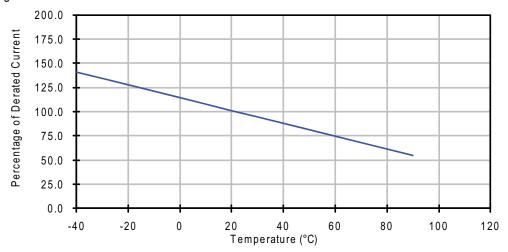


# Time-to-Trip Curves at 23°C



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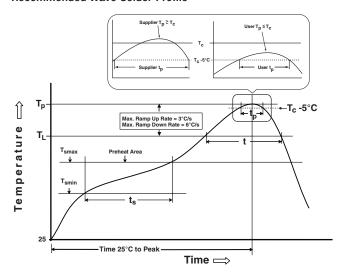
# **Thermal Derating Curve**



## **Soldering Methods**

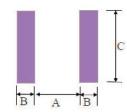
- Wave Solder
  - Reservoir Temperature: 260°C (500°F)
  - Recommended time in reservoir: 10 seconds.
- Infrared Reflow
  - Temperature: 260°C
  - Time: 10 seconds maximum at peak temperature.

### **Recommended Wave Solder Profile**



Environmental Specifications								
Characteristic	Value							
Operating Temperature Range	-40°C to +85°C							
Surface Temperature Trip State	125°C max.							
Thermal Shock	+85°C to -40°C, 10 cycles,							
	5% typical resistance change							
Solvent Resistance	MIL-STD-202 Method 215, no change							
Humidity Age Test	+85°C, 85% RH, 1000 hours							
	±5% typical resistance change.							
	Specified temperature (23°C ± 3°C)							
Storage Temperature Range	-10°C to +40°C							
Storage Duration	One year							
Storage Relative Humidity	≤75%							
Storage Conditions	Keep away from corrosive atmosphere and sunlight							

# Recommended Land Pattern - mm (in)



Α	В	С
2.0 (0.079)	1.0 (0.039)	1.9 (0.075)

# **Material Composition**

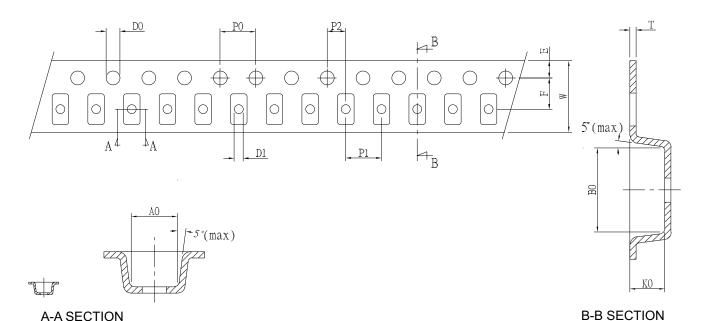
• Terminal material: Nickel/tin-plated copper

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat & Soak		
Temperature min (T <sub>smin</sub> )	100°C	150°C
Temperature max (T <sub>smax</sub> )	150°C	200°C
Time (T <sub>smin</sub> to T <sub>smax</sub> ) (t <sub>S</sub> )	60-120 seconds	60-120 seconds
Average ramp-up rate (T <sub>smax</sub> to T <sub>p</sub> )	3°C/second max.	3°C/second max.
Liquidous temperature (T <sub>L</sub> )	183°C	217°C
Time at liquidous (t <sub>L</sub> )	60-150 seconds	60-150 seconds
Peak package body temperature (T <sub>p</sub> )*	See classification temp in Table 4.1	See classification temp in Table 4.2
Time (t <sub>p</sub> )** within 5°C of the specified	20** seconds	30** seconds
classification temperature (T <sub>c</sub> )		
Average ramp-down rate (T <sub>p</sub> to T <sub>smax</sub> )	6°C/second max.	6°C/second max.
Time 25°C to peak temperature	6 minutes max.	8 minutes max.

\* Tolerance for peak profile temperature  $(T_p)$  is defined as a supplier minimum and a user maximum. \*\* Tolerance for time at peak profile temperature  $(t_p)$  is defined as a supplier minimum and a user maximum.

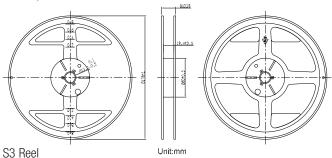
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#### **Packaging Specifications**



I	For PTS120660V005, PTS120660V010, PTS120615V050, PTS12066V100, PTS12066V110, PTS12066V150, PTS12066V200												
Index	A0	В0	K0	P0	P1	P2	T	Е	F	D0	D1	W	10P0
Type	±0.1	±0.1	±0.1	±0.1	±0.1	±0.05	±0.05	±0.1	±0.05	+0.1/-0	Min.	±0.1	±0.2
1206	1.95	3.55	1.35	4.0	4.0	2.0	0.25	1.75	3.5	1.5	1.0	8.1	40.0
Fo	or PTS12	20630V012	2, PTS120	630V016,	PTS1206	624V020, F	PTS12061	6V025, P	TS120616	8V035, PTS	12066V0	)50, PTS1	2066V075
Index	A0	B0	K0	P0	P1	P2	T	Е	F	D0	D1	W	10P0
Type	±0.1	±0.1	±0.1	±0.1	±0.1	±0.05	±0.1	±0.1	±0.05	±0.05	Min.	±0.3	±0.2
1206	1.85	3.45	0.74	4.0	4.0	2.0	0.25	1.75	3.5	1.55	1.0	8.0	40.0

# **Reel Specifications**



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